

(Filing Date)

Attorney Docket No. 36856.636



PECLARATION FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

<

(Application Number)

My residence, post office address I believe I am the original, first ar (if plural names are listed below) invention entitled HIGH FREQ	nd sole inventor (if only one na of the subject matter which is UENCY CIRCUIT CHIP	ame is listed below) or an original claimed and for which a patent in AND METHOD OF PROD	s sought on	the	
the specification of which is attac	hed hereto unless the followin	g box is checked:			
was filed on March 5, 2 Application Number 10,08		tates Application Number or PC	cation Number or PCT International (if applicable).		
I hereby state that I have reviewed claims, as amended by any amended		of the above identified specifica	tion, includi	ng the	
I acknowledge the duty to disclos	e information which is materia	al to patentability as defined in 3	7 CFR § 1.5	i 6 .	
I hereby claim foreign priority be or inventor's certificate, or § 3650 than the United States, listed belo certificate, or PCT International a claimed.	(a) of any PCT International ap w and have also identified bel	oplication which designated at le ow any foreign application for p	ast one cou	ntry other entor's	
Prior Foreign Application(s)	•	Priority Date	Priority C	laimed	
2001-060061	Japan	March 5, 2001	Yes	No	
(Number)	(Country) (PCT)	(Day/Month/Year Filed)			
I hereby claim the benefit under 3	5 U.S.C. § 119(e) of any Unit	ed States provisional application	n(s) listed be	elow.	
(Application Number)		(Filing Date)			

Post Office Address



I hereby claim the benefit under 35 U.S.C. § 120 of any United States application(s), or § 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of 35 U.S.C. § 112, I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application.

TO

(Application Number)	(Filing Date)	(Status - patented, pending, abandoned)
(Application Number)	(Filing Date)	(Status - patented, pending, abandoned)
I hereby appoint the following attorn Patent and Trademark Office connec		s application and to transact all business in the
Joseph R. Keating, Reg. No. 37,368 Christopher A. Bennett, Reg. No. 46		
Address all correspondence to:	Keating & Bennett LLP 10400 Eaton Place, Suite 312 Fairfax, VA 22030 (703) 385-5200	COPY OF PAPERS ORIGINALLY FILED
information and belief are believed t willful false statements and the like	to be true; and further that these stater so made are punishable by fine or im	e true and that all statements made on nents were made with the knowledge that prisonment, or both, under Section 1001 of nay jeopardize the validity of the application or
Full name of first inventor (given na		NAMI
Inventor's signature	+1/23/2002 behingle	Tunamidate 7 April 23,2002
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